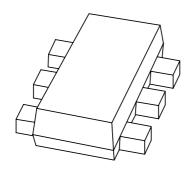
DISCRETE SEMICONDUCTORS

DATA SHEET



BAS40-05VSchottky barrier diodes

Product specification

2002 Nov 21





Schottky barrier diodes

BAS40-05V

FEATURES

- · Low forward voltage
- Absorbs very high surge pulse
- · Low capacitance
- Ultra small SMD plastic package
- Flat leads giving excellent coplanarity and improved thermal behaviour.

APPLICATIONS

- Ultra high-speed switching
- · Voltage clamping
- Board space critical applications.

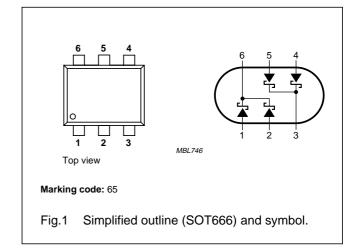
DESCRIPTION

The BAS40-05V consists of two dual Schottky barrier diodes with common cathodes and integrated guard ring for stress protection.

Two separate dice are encapsulated in a SOT666 ultra small SMD plastic package.

PINNING

PIN	DESCRIPTION		
1	anode (a1)		
2	anode (a2)		
3	common cathode (k2)		
4	anode (a3)		
5	anode (a4)		
6	common cathode (k1)		



LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT	
Per diode						
V _R	continuous reverse voltage		_	40	V	
I _F	continuous forward current		_	120	mA	
I _{FRM}	repetitive peak forward current	$t_p < 1 \text{ s; } \delta < 0.5$	_	120	mA	
I _{FSM}	non-repetitive peak forward current	t = 8.3 ms half sinewave; JEDEC method	_	200	mA	
T _{stg}	storage temperature		-65	+150	°C	
Tj	junction temperature		_	150	°C	
T _{amb}	operating ambient temperature		-65	+150	°C	

Schottky barrier diodes

BAS40-05V

ELECTRICAL CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MAX.	UNIT		
Per diode						
V _F	continuous forward voltage	see Fig.2; note 1				
		I _F = 1 mA	380	mV		
		I _F = 10 mA	500	mV		
		I _F = 40 mA	1	V		
I _R	reverse current	see Fig.3; note 1				
		V _R = 30 V	1	μΑ		
		V _R = 40 V	10	μΑ		
C _d	diode capacitance	$V_R = 0 V$; $f = 1 MHz$; see Fig.5	5	pF		

Note

1. Pulsed test: $t_p = 300 \ \mu s$; $\delta = 0.02$.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to ambient	note 1	225	K/W

Note

1. Refer to SOT666 standard mounting conditions.

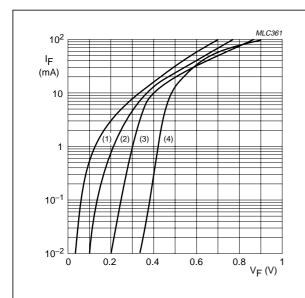
Soldering

The only recommended soldering is reflow soldering.

Schottky barrier diodes

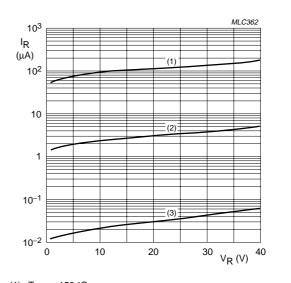
BAS40-05V

GRAPHICAL DATA



- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (3) $T_{amb} = 25 \, ^{\circ}C$.
- (2) $T_{amb} = 85 \,^{\circ}C$.
- (4) $T_{amb} = -40 \, ^{\circ}C$.

Fig.2 Forward current as a function of forward voltage; typical values.



- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) $T_{amb} = 85 \, ^{\circ}C$.
- (3) $T_{amb} = 25 \, ^{\circ}C$.

4

Fig.3 Reverse current as a function of reverse voltage; typical values.

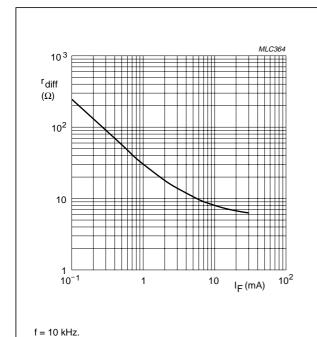


Fig.4 Differential forward resistance as a function of forward current; typical values.

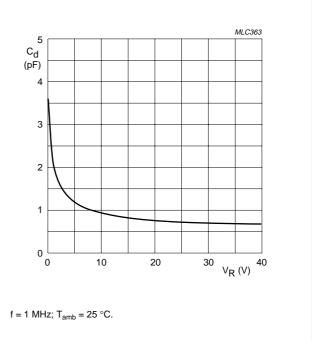


Fig.5 Diode capacitance as a function of reverse voltage; typical values.

2002 Nov 21

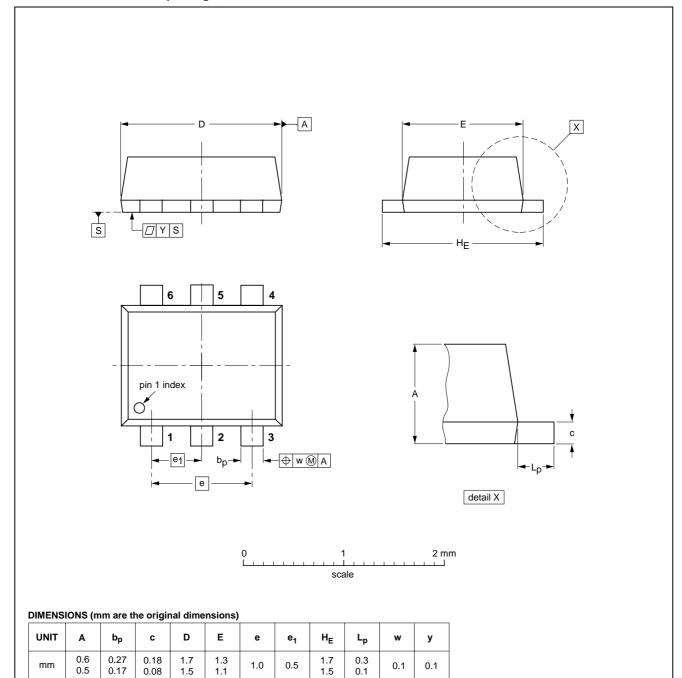
Schottky barrier diodes

BAS40-05V

PACKAGE OUTLINE

Plastic surface mounted package; 6 leads

SOT666



OUTLINE	REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT666						-01-01-04 01-08-27

Schottky barrier diodes

BAS40-05V

DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS(2)(3)	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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Schottky barrier diodes

BAS40-05V

NOTES

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